

### **Features**

- · Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

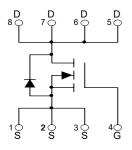
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Maximum Thermal Resistance: 60°C/W Junction to Ambient

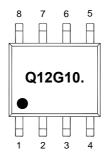
Parameter	Symbol	Rating	Unit
Drain -source Voltage	V <sub>DS</sub>	100	V
Gate -Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	12	Α
Drain Current-Pulse <sup>(Note 1)</sup>	I <sub>DM</sub>	70	Α
Power Dissipation <sup>(Note 2)</sup>	P <sub>D</sub>	3.1	W

#### Notes:

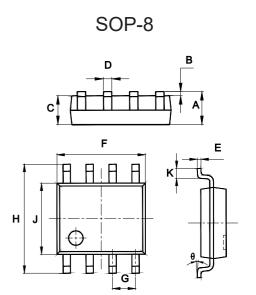
- 1. Pulse Width Limited By Junction Temperature.
- 2. Surface Mounted on 1"x1" FR4 Board, t≤10s.

## **Internal Structure and Marking Code**



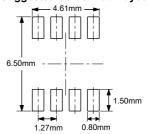


# **N-Channel Power MOSFET**



DIMENSIONS					
DIM	INC	INCHES		М	NOTE
DIIVI	MIN	MAX	MIN	MAX	INOIL
Α	0.053	0.069	1.35	1.75	
В	0.004	0.010	0.10	0.25	
С	0.053	0.061	1.35	1.55	
D	0.013	0.020	0.33	0.51	
E	0.007	0.010	0.17	0.25	
F	0.185	0.200	4.70	5.10	
G	0.050		0 1.270		TYP.
Н	0.228	0.244	5.80	6.20	
J	0.150	0.157	3.80	4.00	
K	0.016	0.050	0.40	1.27	
θ	0°	8°	0°	8°	







# **ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)**

Parameter	Symbol	Test conditions	Min	Тур	Max	Unit	
Static Characteristics	1					ļ	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	100			V	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0	2.8	4.0	V	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			1	μA	
Drain-Source On-Resistance <sup>(Note 3)</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A		14.5	17	mΩ	
Diode Forward Voltage <sup>(Note 3)</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =12A			1.3	V	
Maximum Body-Diode Continuous Current	I <sub>S</sub>				12	Α	
Dynamic Characteristics (Note 4)		•				•	
Input Capacitance	C <sub>iss</sub>			1135			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, f=1MHz		399		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			18			
Gate Resistance	$R_g$	V <sub>DS</sub> =0V,V <sub>GS</sub> =0V, f=1MHz		1		Ω	
Switching Characteristics (Note	4)		<u>'</u>	<u> </u>	1		
Turn-On Delay Time	t <sub>d(on)</sub>			39.2			
Turn-On Rise Time	t <sub>r</sub>	V <sub>GS</sub> =10V,V <sub>DS</sub> =50V,		11		ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_{GEN}$ =2.2 $\Omega$ , $I_D$ =10A		53.2			
Turn-Off Fall Time	t <sub>f</sub>			15.8			
Total Gate Charge(10V)	$Q_g$			16			
Gate-Source Chage	Q <sub>gs</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =10A		5.6		nC	
Gage-Drain Charge	$Q_{gd}$			2.4			
Body Diode Reverse Recovery Time	t <sub>rr</sub>	1 -404 4:/4-4004/		39.8		ns	
Body Diode Reverse Recovery charge	Q <sub>rr</sub>	I <sub>F</sub> =10A,di/dt=100A/μs		42		nC	

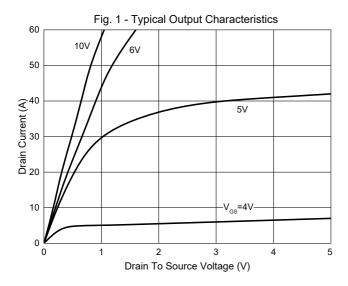
### Notes:

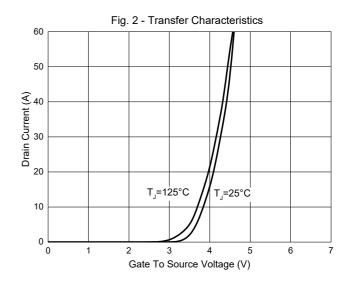
<sup>3.</sup> Pulse Test : Pulse Width≤300µs, Duty Cycle≤2%.

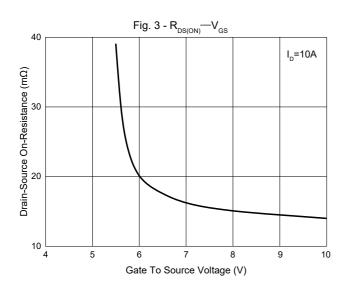
<sup>4.</sup> Guaranteed by Design, Not Subject to Production Testing.

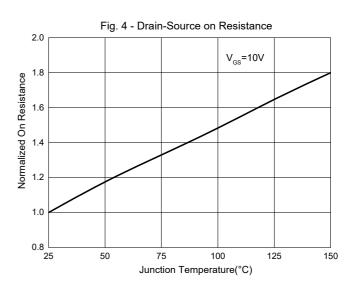


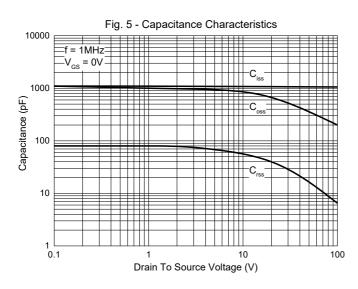
### **Curve Characteristics**

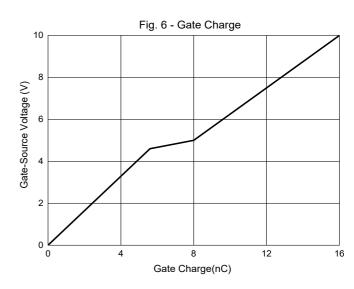






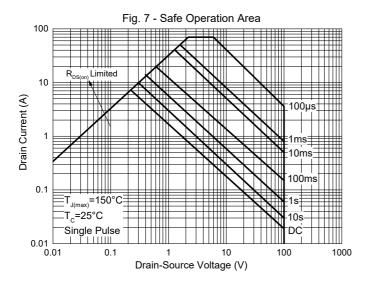


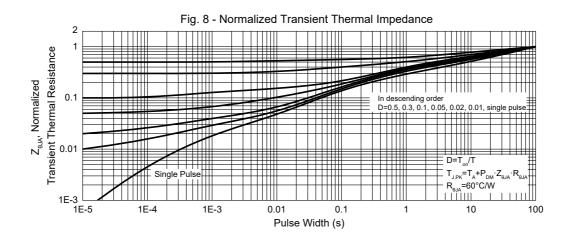






### **Curve Characteristics**





Rev.3-5-05122022 4/5 MCCSEMI.COM



## **Ordering Information**

Device	Packing	
Part Number-TP	Tape&Reel:4Kpcs/Reel	

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